

**SURFACE MOUNT  
FAST SWITCHING DIODE**
**REVERSE VOLTAGE – 250 Volts  
FORWARD CURRENT – 0.2 Amperes**
**FEATURES**

- Fast switching speed
- Ideally suited for automatic insertion
- For general purpose switching applications

**MECHANICAL DATA**

- Case: SOD-123 plastic
- Case Material: “Green” molding compound, UL flammability classification 94V-0, (No Br. Sb. Cl.), “Halogen-free”
- Moisture sensitivity: Level 1 per J-STD-020D
- Lead free in RoHS 2002/95/EC compliant
- Marking Code : JS
- Weight : 11.67m grams (Approximate)

**SOD-123**

**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

Ratings at 25°C ambient temperature unless otherwise specified.

**ABSOLUTE RATINGS**

PARAMETER	SYMBOL	VALUE	UNIT
Continuous reverse voltage	$V_R$	250	V
Peak forward current	$I_F$	200	mA
Peak Forward Surge current @ $t \leq 1\text{ms}$ , Duty:25%	$I_{FM}$	625	mA
Peak Forward Surge current @ $t=8/20\mu\text{s}$	$I_{pp}$	15	A
Power dissipation @ $T_a = 25^\circ\text{C}$ , Derate above $25^\circ\text{C}$ (Note 1)	$P_D$	250	mW
Operation and storage temperature range	$T_J, T_{STG}$	-55 to +150	$^\circ\text{C}$

**STATIC ELECTRICAL CHARACTERISTICS**

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Forward voltage	$I_F = 100\text{ mA}$ $I_F = 200\text{ mA}$	$V_F$	1000 1250	mV
Reverse breakdown voltage	$I_{BR} = 100\mu\text{A}$	$V_{BR}$	250	V
Reverse leakage current	$V_R = 200\text{V}$ $V_R = 200\text{V}$ @ $T_J = 150^\circ\text{C}$	$I_R$	0.1 100	$\mu\text{A}$
Typical junction capacitance	$V_R = 0\text{V}$ , $f = 1\text{MHz}$	$C_D$	5	pF

**THERMAL CHARACTERISTICS**

PARAMETER	SYMBOL	TYP.	UNIT
Typical thermal resistance (Note 1)	$R_{thJA}$	500	$^\circ\text{C/W}$

**DYNAMIC ELECTRICAL CHARACTERISTICS**

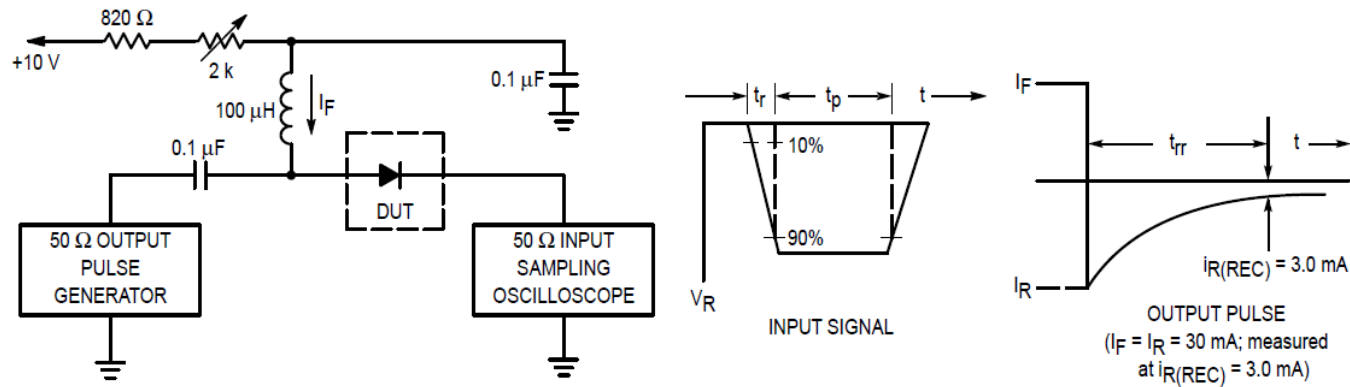
PARAMETER	TEST CONDITION	SYMBOL	TYP.	UNIT
Reverse recovery time	$I_F = I_R = 30\text{mA}$ , $R_L = 100\Omega$	$T_{RR}$	50	ns

**Note :**

(1) Device mounted on FR-5 board, minimum pad

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FIG.1 - RECOVERY TIME EQUIVALENT TEST CIRCUIT



Notes: 1. A 2.0 kΩ variable resistor adjusted for a Forward Current ( $I_F$ ) of 30 mA.  
2. Input pulse is adjusted so  $I_{R(peak)}$  is equal to 30 mA.  
3.  $t_p \gg t_{rr}$

Fig.2 - FORWARD VOLTAGE

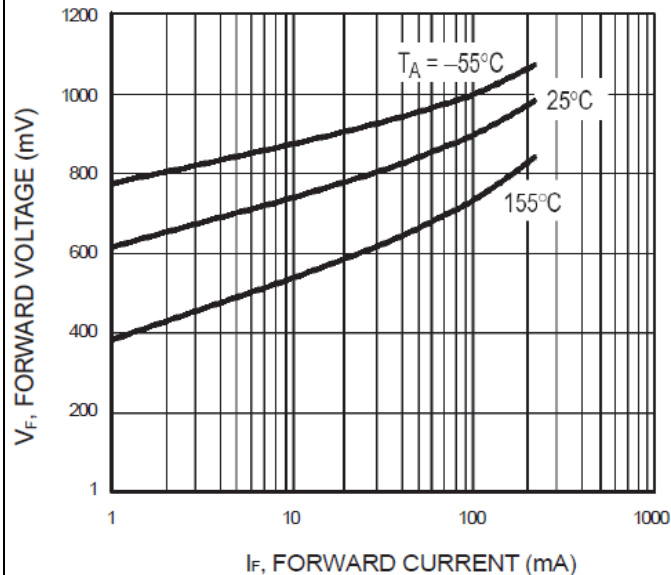


Fig. 3 - REVERSE LEAKAGE

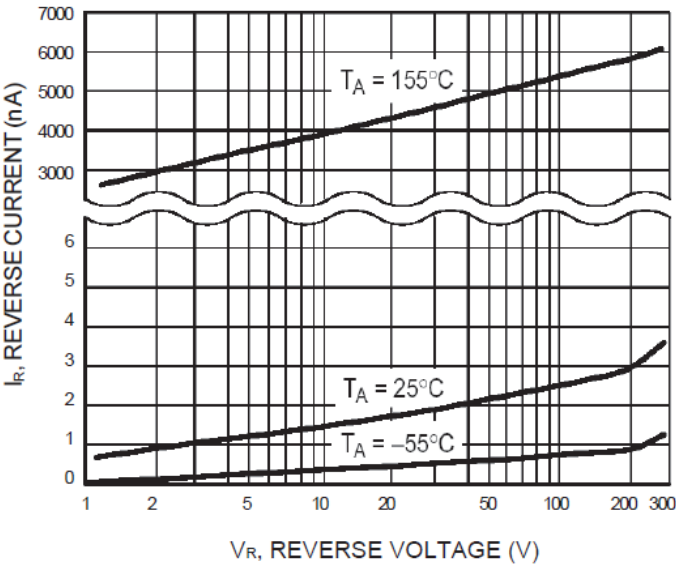
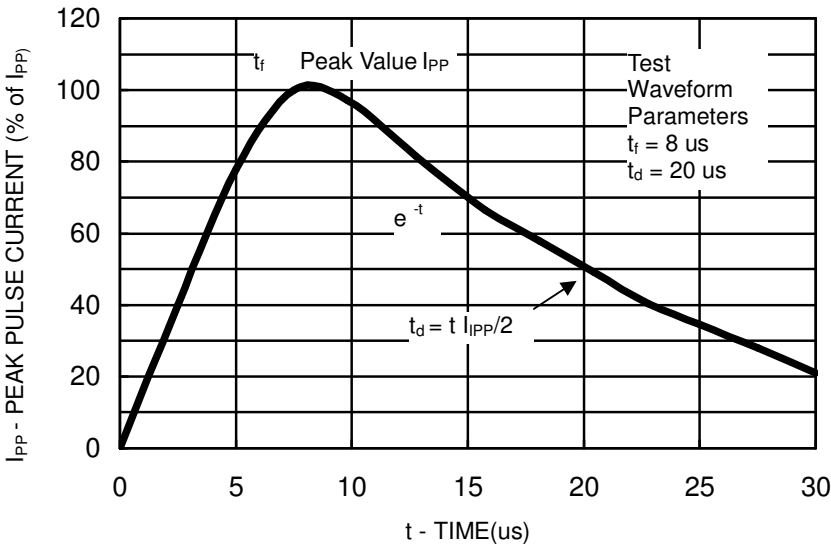
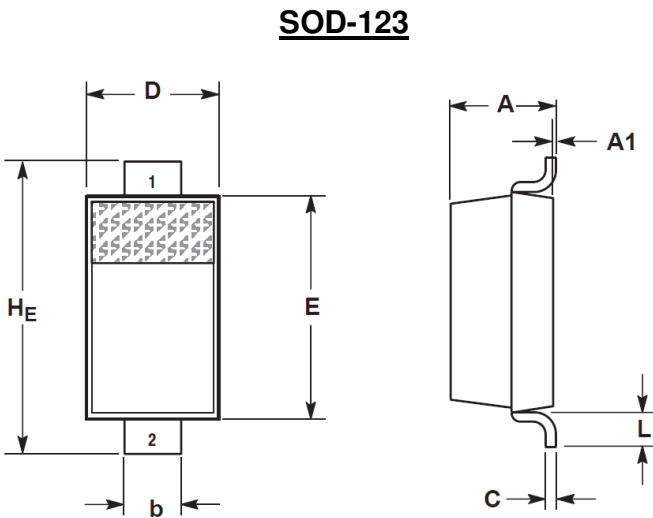


Fig.4 - PULSE WAVEFORM



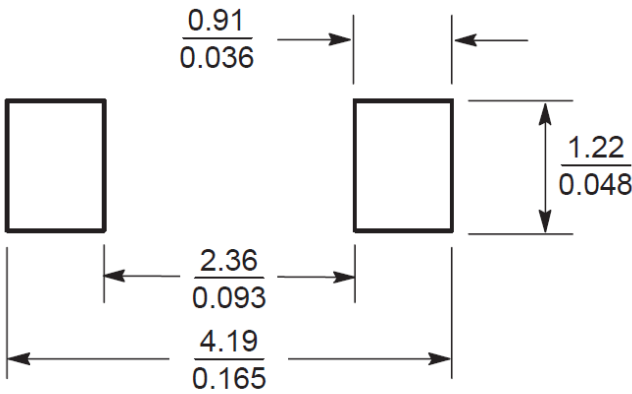
Package Dimensions :



Dim.	INCHES		MILLIMETERS	
	Min.	Max.	Min.	Max.
A	0.037	0.053	0.94	1.35
A1	0.000	0.004	0.00	0.10
b	0.020	0.028	0.51	0.71
c	--	0.006	--	0.15
D	0.055	0.071	1.40	1.80
E	0.100	0.112	2.54	2.84
H <sub>E</sub>	0.140	0.152	3.56	3.86
L	0.010	--	0.25	--

Note:  
PIN 1. Cathode  
PIN 2. Anode

Soldering Pad Layout :



SCALE 10:1  $\left( \frac{\text{mm}}{\text{inches}} \right)$

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